

CIRCUITS	DIM A	DIM B	DIM C	REMARK (無導)	REMARK (有導)
10	3.20	6.00	4.80		⊕
12	4.00	6.80	5.60	⊕	⊕
14	4.80	7.60	6.40		⊕
16	5.60	8.40	7.20		○
18	6.40	9.20	8.00		○
20	7.20	10.00	8.80		○
22	8.00	10.80	9.60		○
24	8.80	11.60	10.40		⊕
26	9.60	12.40	11.20		⊕
28	10.40	13.20	12.00		⊕
30	11.20	14.00	12.80		○
32	12.00	14.80	13.60		○
34	12.80	15.60	14.40		○
36	13.60	16.40	15.20		○
40	15.20	18.00	16.80		⊕
44	16.80	19.60	18.40		○
50	19.20	22.00	20.80	⊕	○
60	23.20	26.00	24.80		○
70	27.20	30.00	28.80		⊕
80	31.20	34.00	32.80		○
90	35.20	38.00	36.80		○
100	39.20	42.00	40.80		○

SPECIFICATIONS

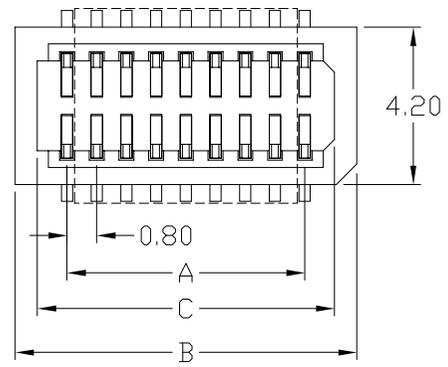
Current Rating: 0.5 Amps
 Insulator resistance: 100 Megohms Min.
 Contact resistance: 40 m ohm Max.
 Dielectric withstanding: AC 500 V
 Operating Temperature: -40° - +105°C
 Contact Material: Phospher bronze
 Insulator Material: High Thermoplastic
 Temperature ,UL 94V-0
 Color: Natural
 Finish: Gold all over nickel

ZIV-XXS2-X-X-*

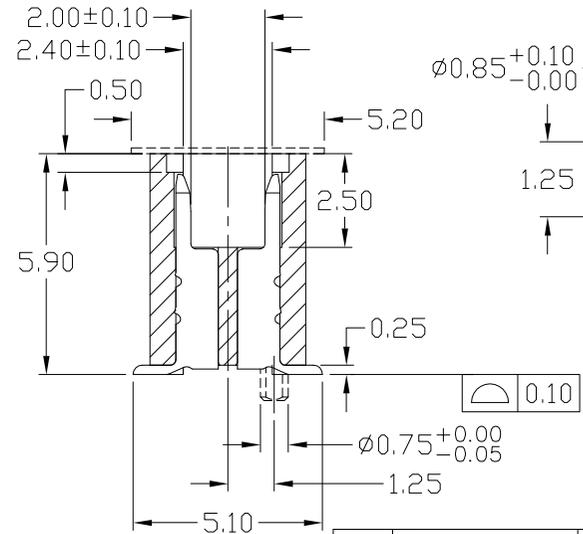
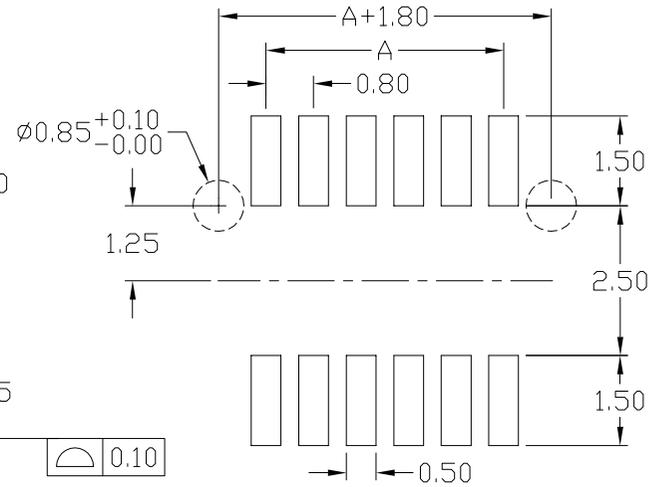
Number of Contacts
 Straight
 NULL:TUBE (W/O FILM)
 K:REEL
 C:FILM+REEL
 F:FILM+TUBE ▲
 1:With Locating peg
 0/W: Locating peg

Contact Plating

Definition	Code
◎ Gold plated:	
flash	B 15μ" F
10μ"	E 30μ" J
◎Standard: B	
◎Prefix "V" means lead free plating.	



Recommended PCB Layout
 (PCB TOLERANCE ±0.05)



$(B-6.50)/2 \pm 0.50$

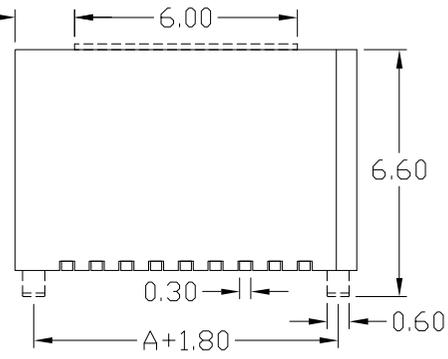


Diagram	Molding description
○	mass production & assemble mold
◎	sample & assemble mold
⊕	mass production & fix mold
⊕	sample & fix mold

Rev.	ECN Number	Description	Drawn	Date
9	EC2-4C0140	新增1 2PIN有導 量產	陳顯鑫	12/13 04'
10	EC2-4C0642	新增4 4PIN規格	陳美竹	12/30 04'
11	EC2-590053	新增包裝代碼 F	詹益東	09/12 05'



GENERAL TOLERANCE		SCALE	ORIGINAL DRAWN	DATE
XX. ± 0.50	XXX. ±	1=1	林秋蘭	02'/07/02
X. ± 0.30	.XXX ±	UNIT	林錫錦	09/12 05'
.X ± 0.25	.X* ± 4°	MM	林錫錦	09/12 05'
.XX ± 0.20	.X* ± 4°	SIZE		

APPROVE	CHECK
林錫錦	林錫錦

DATE	DATE	DATE
02'/07/02	09/12 05'	09/12 05'

DWG. NO.	TITLE
X-XX	0.80mm SMD SOCKET (成品規格圖)

REV.	SHEET
11	1/1